



IEC 62631-2-1

IEC 62631-3-1

IEC 62631-3-2

HOSTAFORM® C 27021 LS colored

HOSTAFORM®

POM copolymer

Very easy flowing Injection molding type with high rigidity and hardness; with UV additives, mass colored Burning rate ISO 3795 and FMVSS 302 < 75 mm/min for a thickness more than 1 mm. FMVSS = Federal Motor Vehicle Safety Standard (USA)

Product information			
Resin Identification	POM		ISO 1043
Part Marking Code	>POM<		ISO 11469
Rheological properties			
Melt volume-flow rate		cm ³ /10min	ISO 1133
Temperature	190		
Load	2.16		100 004 4 0577
Moulding shrinkage, parallel	1.9 1.8		ISO 294-4, 2577 ISO 294-4, 2577
Moulding shrinkage, normal	1.0	70	150 294-4, 2577
Typical mechanical properties			
Tensile modulus	2900		ISO 527-1/-2
Tensile stress at yield, 50mm/min		MPa	ISO 527-1/-2
Tensile strain at yield, 50mm/min	7.5		ISO 527-1/-2
Nominal strain at break	17		ISO 527-1/-2
Flexural modulus Tensile creep modulus, 1h	2800 2500		ISO 178 ISO 899-1
Tensile creep modulus, 1000h	1300		ISO 899-1
Charpy impact strength, 23°C		kJ/m ²	ISO 179/1eU
Charpy impact strength, -30 °C		kJ/m²	ISO 179/1eU
Charpy notched impact strength, 23°C	5.5	kJ/m²	ISO 179/1eA
Charpy notched impact strength, -30°C		kJ/m²	ISO 179/1eA
Ball indentation hardness, H 358/30		MPa	ISO 2039-1
Poisson's ratio	0.37 ^[C]		
[C]: Calculated			
Thermal properties			
Melting temperature, 10 °C/min	166	°C	ISO 11357-1/-3
Temperature of deflection under load, 1.8 MPa	106	°C	ISO 75-1/-2
Coefficient of linear thermal expansion	110	E-6/K	ISO 11359-1/-2
(CLTE), parallel	0.455	M// 10	100 0007 0
Thermal conductivity of melt		W/(m K)	ISO 22007-2
Specific heat capacity of melt	2210	J/(kg K)	ISO 22007-4
Electrical properties			
Relative permittivity, 100Hz	4		IEC 62631-2-1
Relative permittivity, 1MHz	4		IEC 62631-2-1
Dissipation factor, 100Hz	25	E-4	IEC 62631-2-1

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50 E-4

1E14 Ohm

1E12 Ohm.m

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Dissipation factor, 1MHz

Volume resistivity

Surface resistivity





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Electric strength	35 kV/mm	IEC 60243-1
Comparative tracking index	600	IEC 60112

Physical/Other properties

Humidity absorption, 2mm	0.2 %	Sim. to ISO 62
Water absorption, 2mm	0.65 %	Sim. to ISO 62
Density	1410 kg/m³	ISO 1183

Injection

Drying Recommended	no	
Drying Temperature	100 °	,C
Drying Time, Dehumidified Dryer	3-4 h	1
Processing Moisture Content	≤0.2 %	%
Melt Temperature Optimum	200 °	,C
Min. melt temperature	190 °	,C
Max. melt temperature	210 °	,C
Screw tangential speed	≤0.3 n	n/s
Mold Temperature Optimum	100 °	,C
Min. mould temperature	80 °	,C
Max. mould temperature	120 °	,C
Hold pressure range	60 - 120 N	ИРа
Back pressure	4 N	ИРа
Ejection temperature	140 °	°C

Characteristics

Processing Injection Moulding

Delivery form **Pellets**

Additives Release agent

U.V. stabilised or stable to weather, High Flow Special characteristics

Additional information

Injection molding Preprocessing

> General drying is not necessary due to low moisture absorption of the resin.

In case of bad storage conditions (water contact or condensed water) the use of a recirculating air dryer (100 to 120 °C / max. 40 mm

layer / 3 to 6 hours) is recommended.

Max. Water content 0,2 %

Processing

Standard injection moulding machines with three phase (15 to 25 D) plasticating screws will fit.

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Postprocessing

Conditioning e.g. moisturizing is not necessary.

Processing Notes

Pre-Drying

Drying is not normally required. If material has come in contact with moisture through improper storage or handling or through regrind use, drying may be necessary to prevent splay and odor problems.

Storage

The product can then be stored in standard conditions until processed.

Automotive

OEM STANDARD ADDITIONAL INFORMATION

Ford WSK-M4D840-A3 100% Color Match

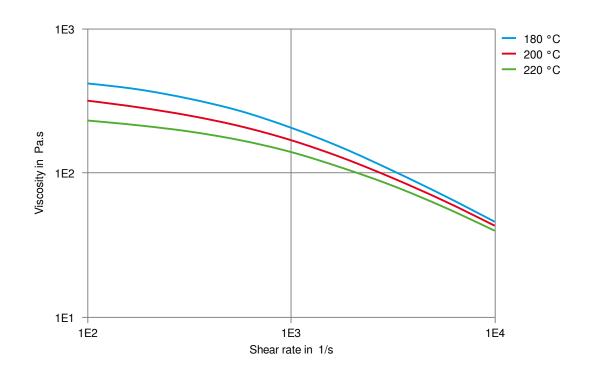
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Viscosity-shear rate



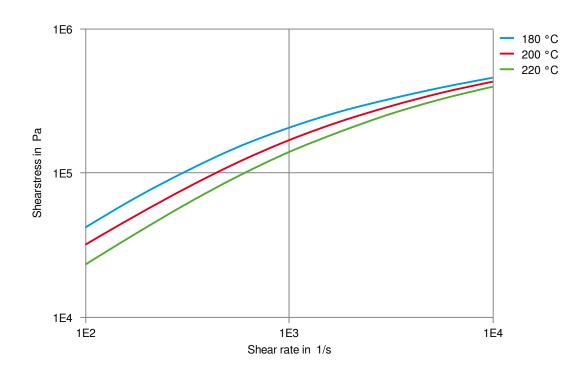
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Shearstress-shear rate



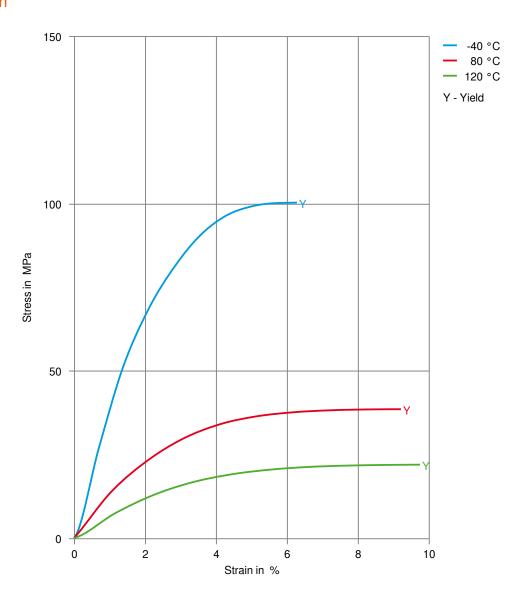
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Stress-strain



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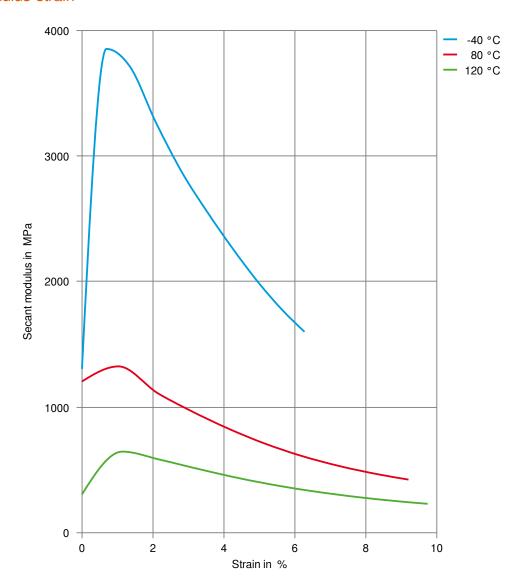




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Secant modulus-strain



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